STSJ80N4LLF3

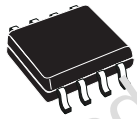
N-channel 40V - 0.0042Ω - 18A - PowerSO-8™ STripFET™III Power MOSFET for DC-DC conversion

General features

Type	V_{DSS}	$R_{DS(on)}$	I_D
STSJ80N4LLF3	40V	0.005Ω	18A(1)

1. This value is rated according to Rthj-pcb

- Optimal $R_{DS(on)}$ x Qg trade-off @ 4.5V
- Switching losses reduced
- Low threshold device
- Improved junction-case thermal resistance

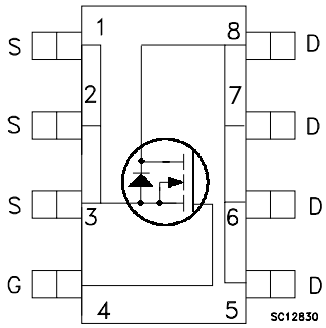


PowerSO-8

Description

This series of product utilizes the latest advanced design rules of ST's proprietary STripFET™ technology. This process coupled to unique metallization techniques realizes the most advanced low voltage Power MOSFET in SO-8 ever produced. The exposed slug reduces the Rthj-c improving the current capability.

Internal schematic diagram



DRAIN CONTACT ALSO ON THE BACKSIDE

Applications

- Switching application

Order codes

Part number	Marking	Package	Packaging
STSJ80N4LLF3	80N4LL-	PowerSO-8	Tape & reel

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Contents

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1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (V_{GS} = 0)	40	V
V_{GS}	Gate- source voltage	± 16	V
V_{GS} (1)	Gate- source voltage	±18	V
I_D (2)	Drain current (continuous) at T_C = 25°C	80	A
I_D (3)	Drain current (continuous) at T_C = 25°C	18	A
I_D (2)	Drain current (continuous) at T_C = 100°C	50	A
I_{DM} (4)	Drain current (pulsed)	72	A
P_{tot} (2)	Total dissipation at T_C = 25°C	70	W
P_{tot} (3)	Total dissipation at T_C = 25°C	3	W
Tj Tstg	Maximum operating junction temperature Storage temperature	-55 to 150	°C

1. Guaranteed for test time ≤ 15ms
2. This value is rated according to Rthj-c
3. This value is rated according to Rthj-pcb
4. Pulse with limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thj-c}	Thermal resistance junction-case max	1.8	°C/W
$R_{thj-pcb}$ (1)	Thermal resistance junction-pcb max	42	°C/W

1. When mounted on 1 inch² FR-4 board, 2oz Cu (t<10sec.)

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2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	I_D = 250µA, V_{GS} = 0	40			V
I_{DSS}	Zero gate voltage drain current (V_{GS} = 0)	V_{DS} = 40V, T_C = 25°C V_{DS} = 40V, T_C = 125°C			10 100	µA µA
I_{GSS}	Gate-body leakage current (V_{DS} = 0)	V_{GS} = ± 16V			±200	nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 250µA	1			V
$R_{DS(on)}$	Static drain-source on resistance	V_{GS} = 10V, I_D = 9A V_{GS} = 4.5V, I_D = 9A		0.0042 0.005	0.005 0.007	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss} C_{oss} C_{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V_{DS} = 25V, f = 1MHz, V_{GS} = 0		2530 574 29		pF pF pF
Q_g Q_{gs} Q_{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 20V, I_D = 18A V_{GS} = 4.5V *(see Figure 13)*		21.5 6.9 8.2	28	nC nC nC
R_G	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20mV open drain	1	3	5	Ω

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Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r	Turn-on delay time Rise time	V_{DD} = 20V, I_D = 9A R_G = 4.7Ω, V_{GS} = 10V *(see Figure 15)*		17 25		ns ns
$t_{d(off)}$ t_f	Turn-off delay time Fall time	V_{DD} = 20V, I_D = 9A R_G = 4.7Ω, V_{GS} = 10V *(see Figure 15)*		62 9		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD} I_{SDM}	Source-drain current Source-drain current (pulsed)				18 72	A A
V_{SD}(1)	Forward on voltage	I_{SD} = 18A, V_{GS} = 0			1.2	V
t_{rr} Q_{rr} I_{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 18A, di/dt = 100A/µs V_{DD} = 30V, T_j = 150°C *(see Figure 14)*		43 64 3		ns nC A

1. Pulsed: pulse duration = 300µs, duty cycle 1.5%

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2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

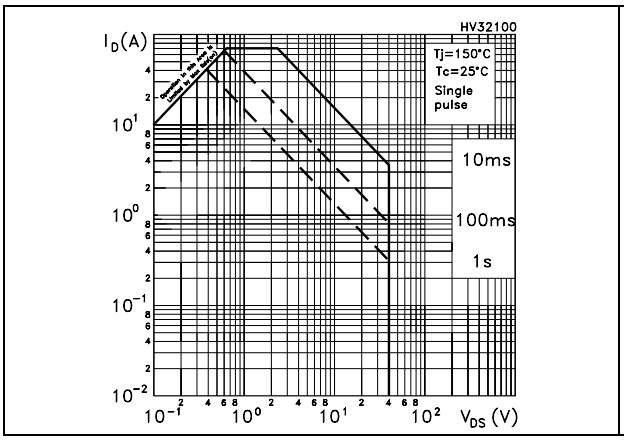

Figure 2. Thermal impedance

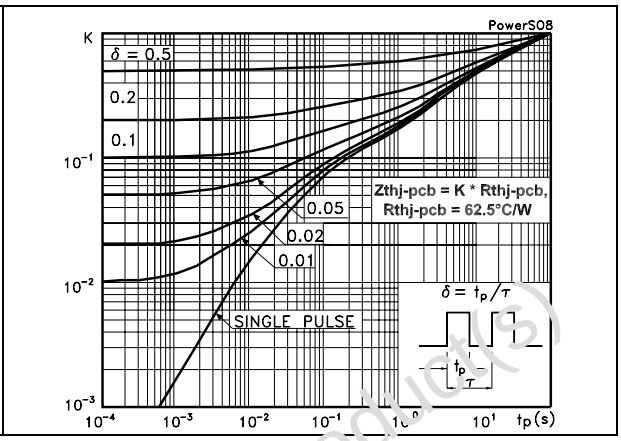

Figure 3. Output characterisics

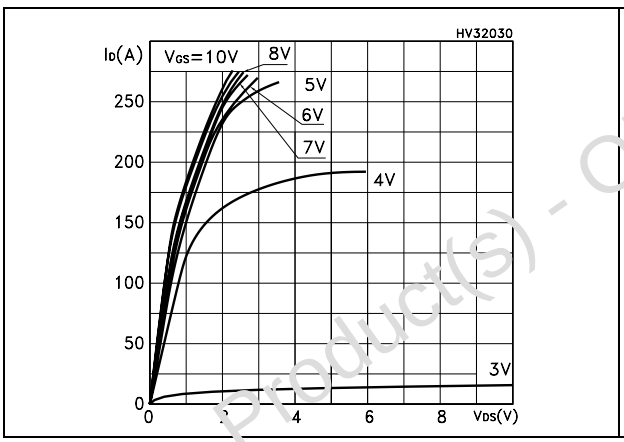

Figure 4. Transfer characteristics

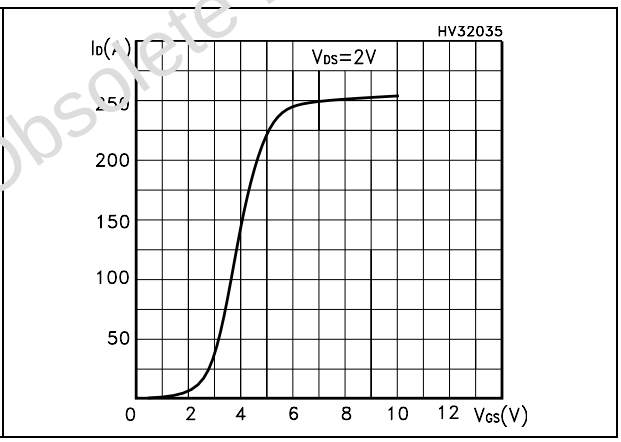

Figure 5. Normalized B_{VDSS} vs temperature

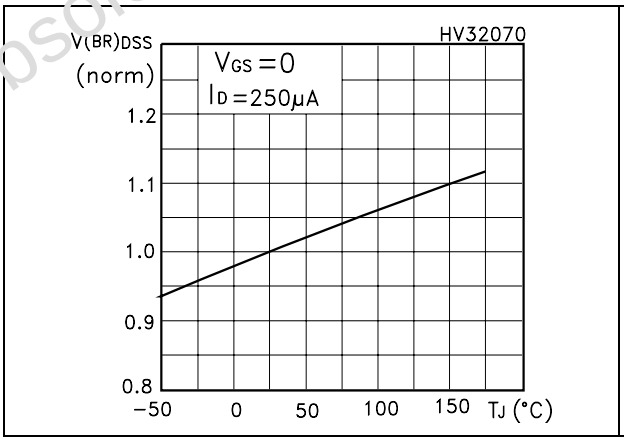

Figure 6. Static drain-source on resistance

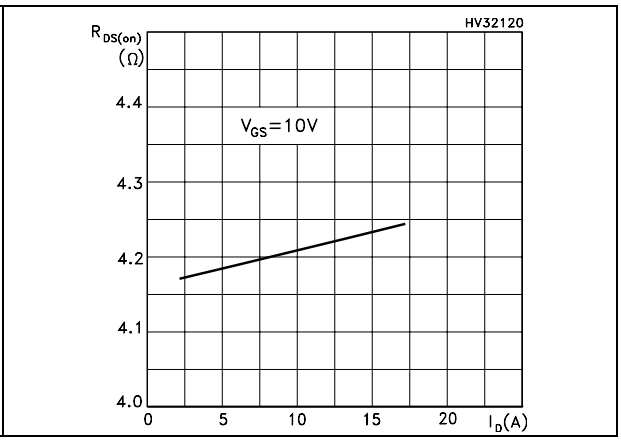

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Figure 7. Gate charge vs gate-source voltage

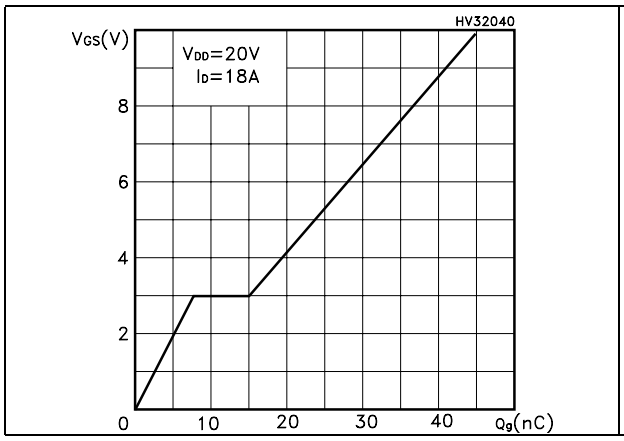


Figure 8. Capacitance variations

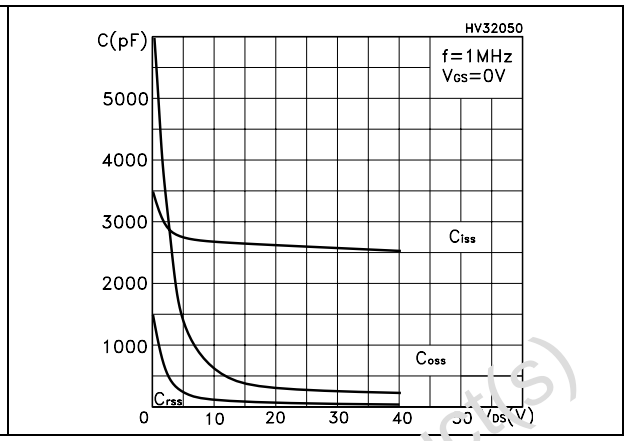


Figure 9. Normalized gate threshold voltage vs temperature

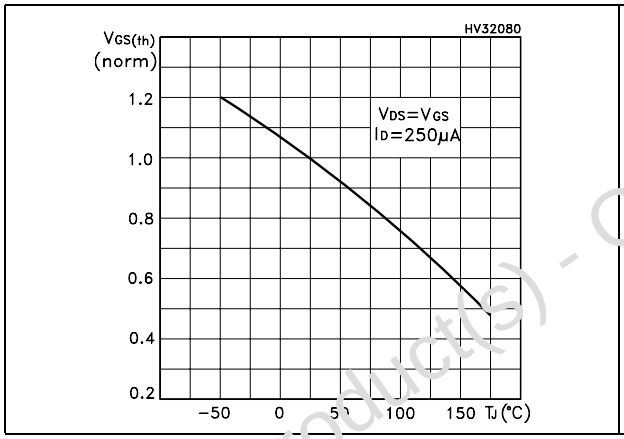


Figure 10. Normalized on resistance vs temperature

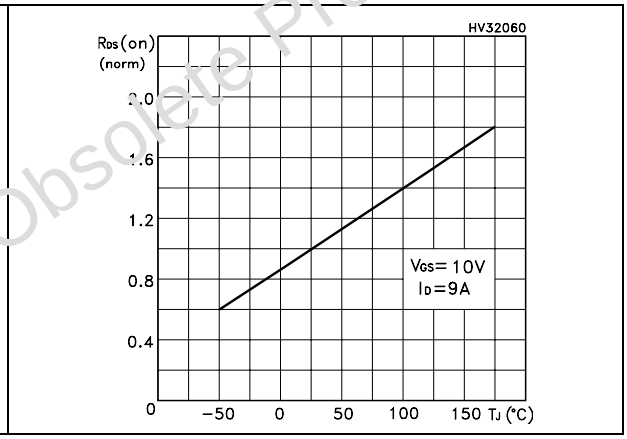
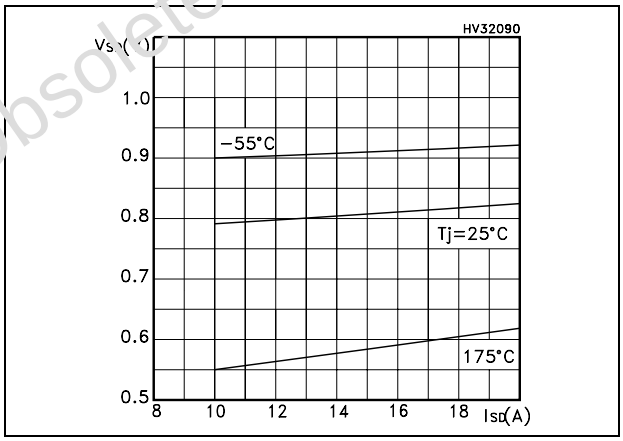


Figure 11. Source-drain diode forward characteristics



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3 Test circuit

Figure 12. Switching times test circuit for resistive load

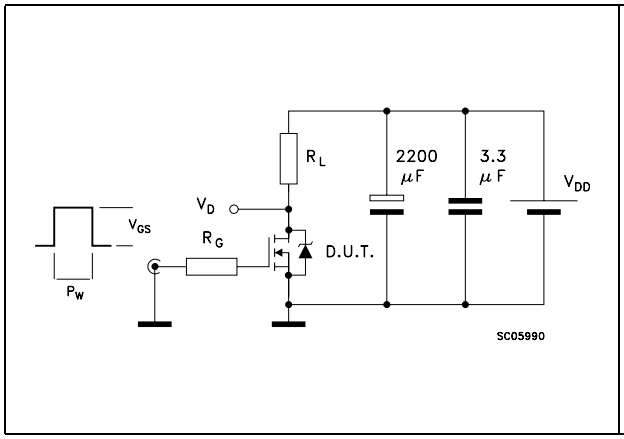


Figure 13. Gate charge test circuit

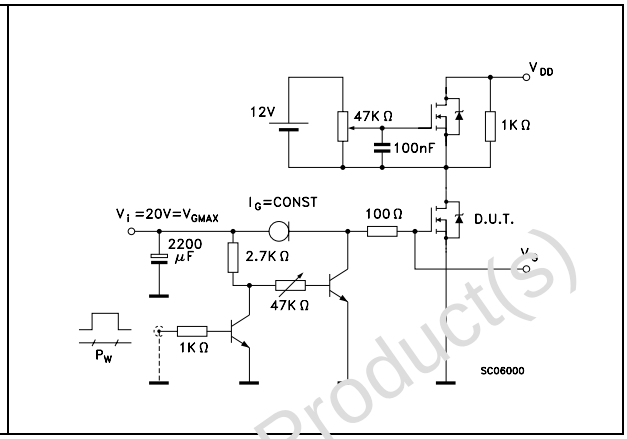


Figure 14. Test circuit for inductive load switching and diode recovery times

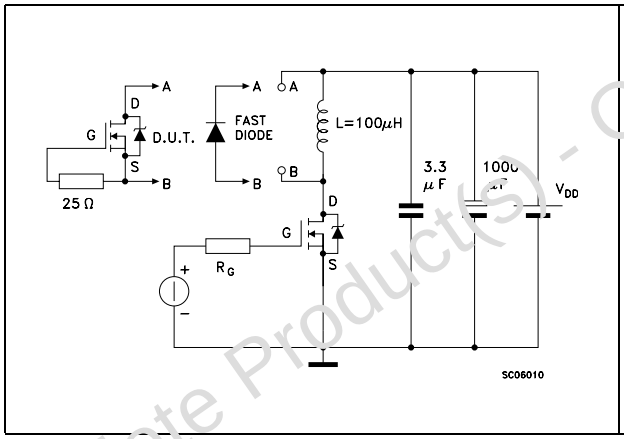


Figure 15. Unclamped inductive load test circuit

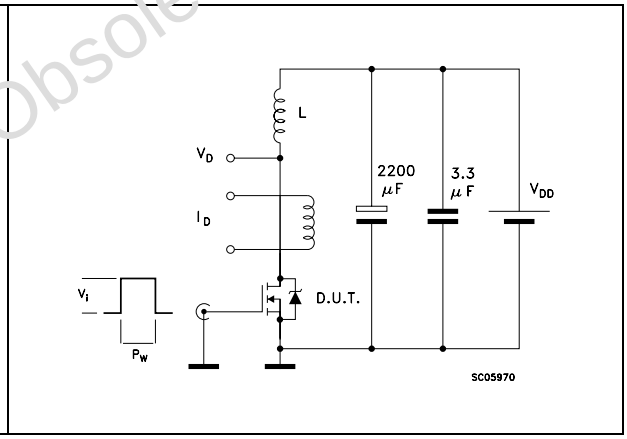


Figure 16. Unclamped inductive waveform

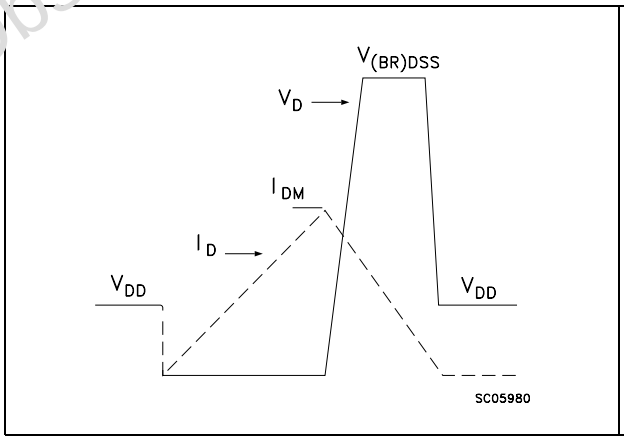
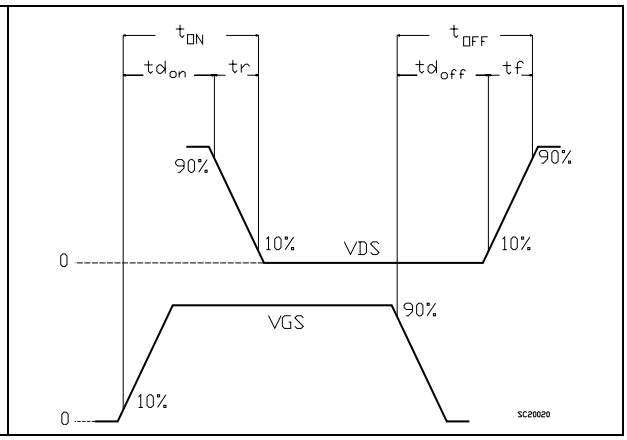


Figure 17. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com*

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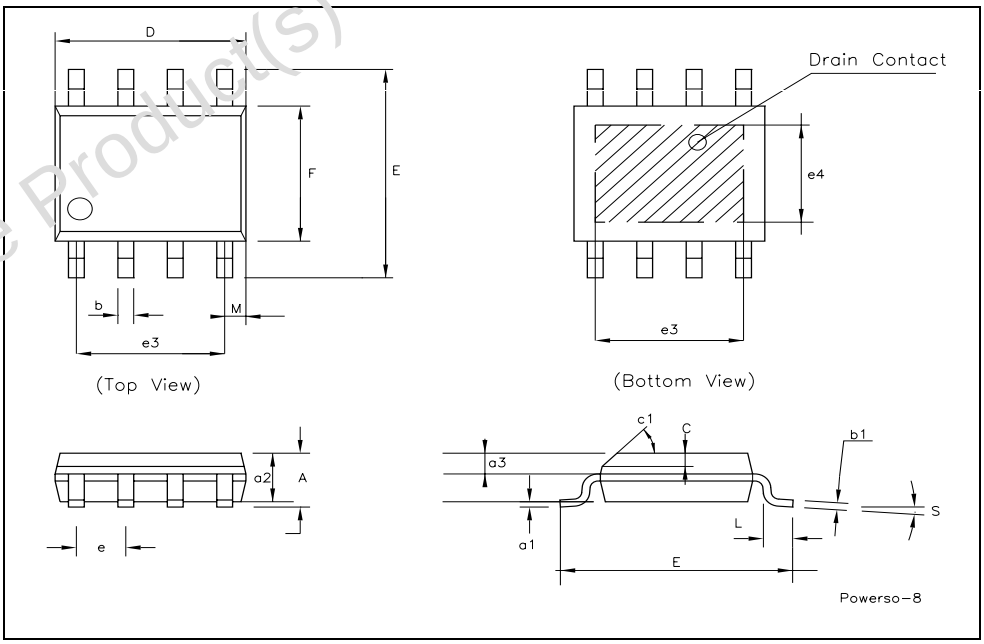
PowerSO-8™ MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1	45° (typ.)					
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
e4		2.79			0.110	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S	8° (max.)					



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5 Revision history

Table 7. Revision history

Date	Revision	Changes
13-May-2005	1	Initial release.
23-Jun-2006	2	New template, complete version
22-Nov-2006	3	Corrected part number

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